

General Description

The WSD3045DN is the highest performance trench N-ch and P-ch MOSFETs with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The WSD3045DN meet the RoHS and Green Product requirement , 100% EAS guaranteed with full function reliability approved.

Product Summery

BVDSS	RDSON	ID
30V	10.5mΩ	18A
-30V	24mΩ	-15.3A

DFN3.3x3.3_8_EP1 Pin Configuration

Applications

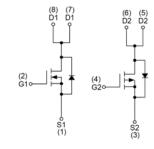
Synchronous Rectification.

Motor Control.

High Current, High Speed Switching.

Protable equipment application.





Absolute Maximum Ratings

Symbol	Parameter	Rati		
Symbol	Falantelei	N-Channel	P-Channel	Units
V _{DS}	Drain-Source Voltage	30	-30	V
V _{GS}	Gate-Source Voltage	±20	±20	V
I _D @T _C =25℃	Continuous Drain Current, V _{GS} @ 10V ¹	18	-15.3	А
I _D @T _C =100℃	Continuous Drain Current, V _{GS} @ 10V ¹	7	-8.4	А
I _{DM}	Pulsed Drain Current ²	44	-53	А
EAS	Single Pulse Avalanche Energy ³	7.3	20	mJ
I _{AS}	Avalanche Current	5.4	-9	А
P _D @T _C =25℃	Total Power Dissipation ⁴	2.1	2.1	W
T _{STG}	Storage Temperature Range	-55 to 150	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	-55 to 150	°C

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
R _{θJA}	Thermal Resistance Junction-Ambient ¹		85	°C/W
R _{θJC}	Thermal Resistance Junction-Case ¹		50	°C/W



Electrical Characteristics (T_J=25 $^{\circ}$ C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30			V
$\triangle BV_{DSS} / \triangle T_J$	BVDSS Temperature Coefficient	Reference to $25^\circ C$, I _D =1mA		0.034		V/℃
В	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =6A		8.5	10.5	m 0
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =4.5V , I _D =5A		10	14	mΩ
V _{GS(th)}	Gate Threshold Voltage		1.3	1.8	2.5	V
$ riangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	$V_{GS} = V_{DS}$, $I_D = 2500A$		-5.8		mV/℃
		V_{DS} =30V , V_{GS} =0V , T_{J} =25 $^{\circ}$ C			1	1 5 uA
I _{DSS}	Drain-Source Leakage Current	V _{DS} =30V , V _{GS} =0V , T _J =55℃			5	
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm20V$, $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V _{DS} =15V , I _D =5A		10		S
R _g	Gate Resistance	V _{DS} =24V , V _{GS} =0V , f=1MHz		2.5		Ω
Qg	Total Gate Charge (4.5V)			2.7		
Q _{gs}	Gate-Source Charge	V _{DS} =20V , V _{GS} =4.5V , I _D =6A		1.3		nC
Q _{gd}	Gate-Drain Charge			1.7		
T _{d(on)}	Turn-On Delay Time			5		
Tr	Rise Time	V_{DD} =12V , V_{GS} =10V , R_{G} =3.3 Ω		11		
T _{d(off)}	Turn-Off Delay Time	I _D =5A		11.5		ns
T _f	Fall Time			2.6		
C _{iss}	Input Capacitance			250		
C _{oss}	Output Capacitance	V _{DS} =25V , V _{GS} =0V , f=1MHz		40		рF
Crss	Reverse Transfer Capacitance			30		

Guaranteed Avalanche Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy 5	V _{DD} =25V , L=0.5mH , I _{AS} =10A	5			mJ

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,6}	$V_G=V_D=0V$, Force Current			6	А
I _{SM}	Pulsed Source Current ^{2,6}				15	А
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =5A , TJ=25℃			1.2	V

Note :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper,t<10sec.

2.The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%

3. The EAS data shows Max. rating . The test condition is $V_{\text{DD}}\text{=}25\text{V}, V_{\text{GS}}\text{=}10\text{V}, \text{L=}0.5\text{mH}, \text{I}_{\text{AS}}\text{=}10\text{A}$

4.The power dissipation is limited by 150° C junction temperature

5.The Min. value is 100% EAS tested guarantee.

6.The data is theoretically the same as I_{D} and I_{DM} , in real applications , should be limited by total power dissipation.



Electrical Characteristics (TJ=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} =0V , I _D =-250uA	-30			V
$\triangle BV_{DSS} / \triangle T_J$	BV _{DSS} Temperature Coefficient	Reference to 25 $^\circ\!\mathrm{C}$, I_D=-1mA		-0.085		V/℃
P	Static Drain-Source On-Resistance ²	V _{GS} =-10V , I _D =-6A		20	24	mΩ
R _{DS(ON)}		V _{GS} =-4.5V , I _D =-3A		30	38	1115.2
V _{GS(th)}	Gate Threshold Voltage		-1.0	-1.8	-2.5	V
$ riangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient			0.375		mV/℃
	Drain Source Lookage Current	$V_{\text{DS}}\text{=-}24\text{V}$, $V_{\text{GS}}\text{=}0\text{V}$, $T_{\text{J}}\text{=}25^\circ\!\mathrm{C}$			1	
I _{DSS}	Drain-Source Leakage Current	V_{DS} =-24V , V_{GS} =0V , T_J =55 $^\circ\!\mathrm{C}$			5	uA
I _{GSS}	Gate-Source Leakage Current	V_{GS} = $\pm20V$, V_{DS} = $0V$			±100	nA
gfs	Forward Transconductance	V _{DS} =-10V , I _D =-6A		6		S
Qg	Total Gate Charge (-4.5V)			6		
Q _{gs}	Gate-Source Charge	$V_{\text{DS}}\text{=-}20\text{V}$, $V_{\text{GS}}\text{=-}4.5\text{V}$, $I_{\text{D}}\text{=-}6\text{A}$		2		nC
Q _{gd}	Gate-Drain Charge			3		
T _{d(on)}	Turn-On Delay Time			8.7		
Tr	Rise Time	$V_{DD}\text{=-12V}$, $V_{GS}\text{=-10V}$, $R_{G}\text{=}3.3\Omega,$		10		ns
T _{d(off)}	Turn-Off Delay Time	I _D =-5A		22		115
T _f	Fall Time			9		
C _{iss}	Input Capacitance			880		
Coss	Output Capacitance	V_{DS} =-25V , V_{GS} =0V , f=1MHz		145		pF
C _{rss}	Reverse Transfer Capacitance			92		

Guaranteed Avalanche Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy 5	V _{DD} =-25V , L=0.5mH , I _{AS} =-10A	16			mJ

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current ^{1,6}	$V_G = V_D = 0V$, Force Current			-6.6	А
I _{SM}	Pulsed Source Current ^{2,6}				-15.5	A
V _{SD}	Diode Forward Voltage ²	V_{GS} =0V , I_{S} =-6A , T_{J} =25 $^{\circ}$ C			-1.2	V

Note :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper,t<10sec.

2.The data tested by pulsed , pulse width $\,\leq\,$ 300us , duty cycle $\,\leq\,$ 2%

3. The EAS data shows Max. rating . The test condition is V_{DD} =-25V, V_{GS} =-10V, L=0.5mH, I_{AS} =-10A

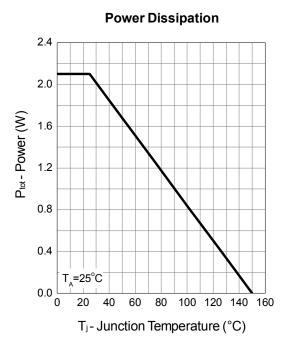
4. The power dissipation is limited by 150 °C junction temperature

5. The Min. value is 100% EAS tested guarantee.

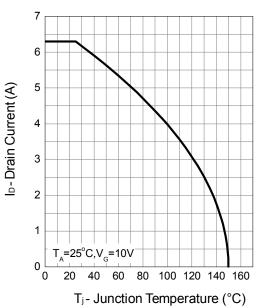
6. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



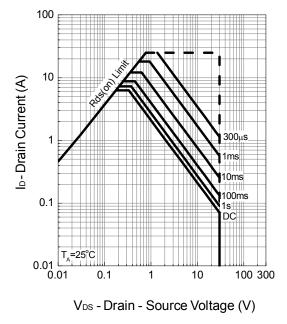
N-Channel Typical Characteristics



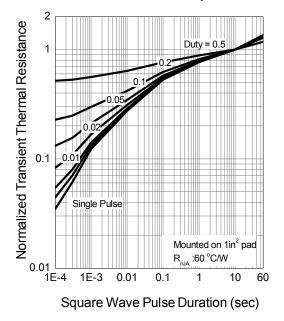
Drain Current



Safe Operation Area

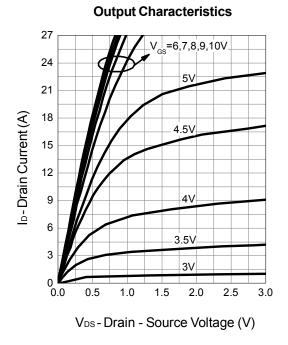


Thermal Transient Impedance



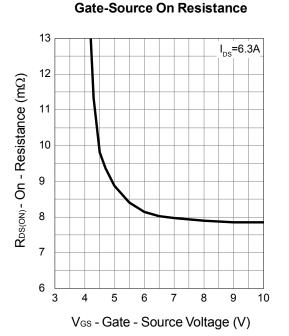


N-Channel Typical Characteristics

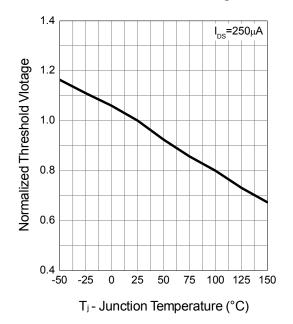


14 13 V_{GS}=4.5V R_{DS(ON)} - On - Resistance (mΩ) 12 11 10 9 V_{GS}=10V 8 7 6 5 5 10 15 20 0 25 ID-Drain Current (A)

Drain-Source On Resistance



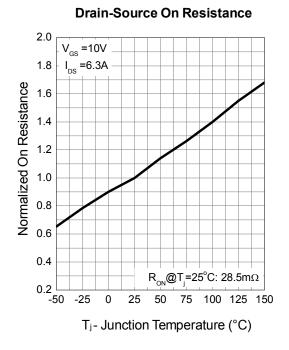
Gate Threshold Voltage



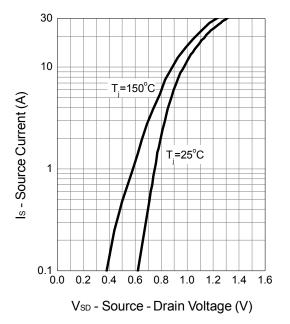


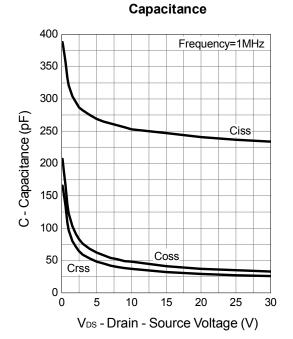


N-Channel Typical Characteristics

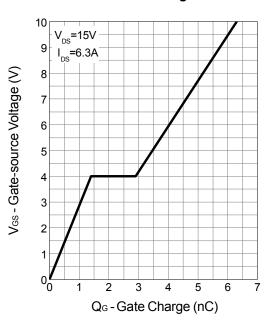


Source-Drain Diode Forward





Gate Charge

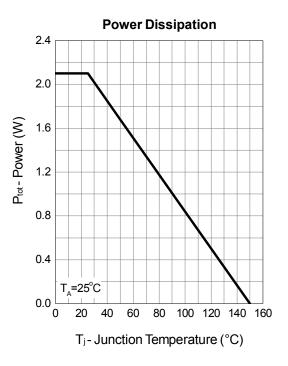


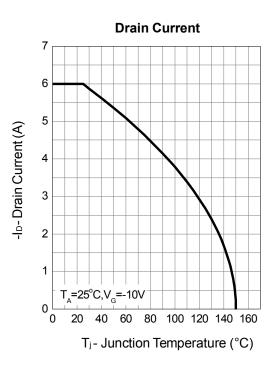


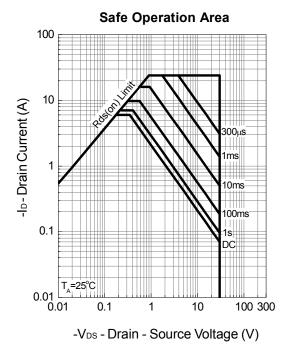
WSD3045DN

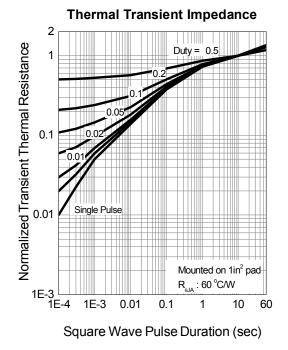
N-Ch and P-Channel MOSFET

P-Channel Typical Characteristics



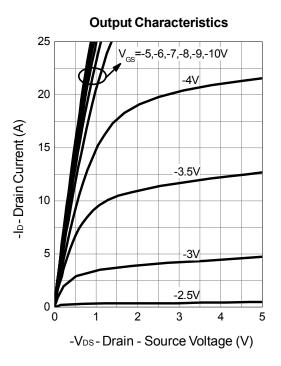








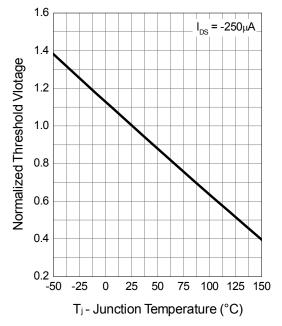
P-Channel Typical Characteristics



Drain-Source On Resistance 90 75 R_{DS(ON)} - On - Resistance (mΩ) 60 V_{GS}=-4.5V 45 -10\ V_{GS}=∙ 30 15 0 5 10 15 0 20 25 -ID- Drain Current (A)

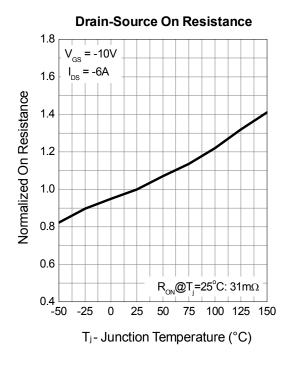
Gate-Source On Resistance 120 I_{DS}=-6A 100 $R_{DS(ON)}$ - On - Resistance (m Ω) 80 60 40 20 0∟ 2 3 4 5 6 7 8 9 10 -VGS - Gate - Source Voltage (V)

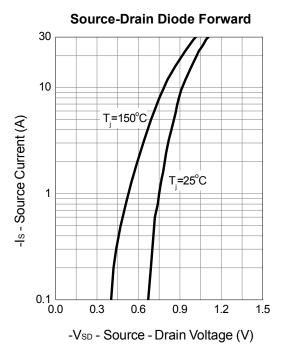
Gate Threshold Voltage

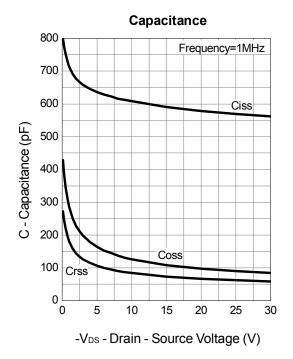


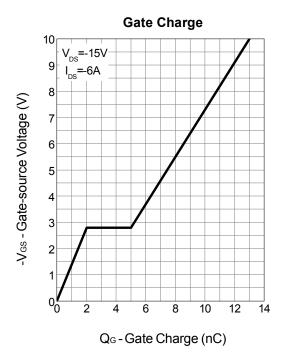


P-Channel Typical Characteristics









WSD3045DN

N-Ch and P-Channel MOSFET



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All Dimension Are ln mm.

Package Body Sizes Exclude Mold Flash, Protrusion Or Gate Burrs.

Mold Flash, Protrusion Or Gate Burrs Shall Not Exceed 0.10 mm Per Side.

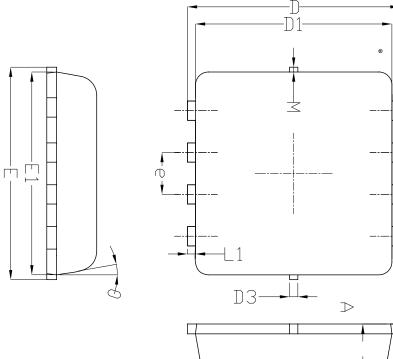
Package Body Sizes Determined At The Outermost Extremes Of The Plastic Body

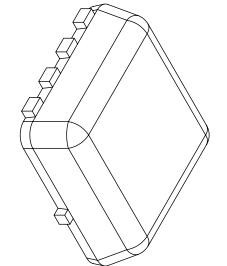
Exclusive Of Mold Flash, Tie Bar Burrs, Gate Burrs And Interlead Flash,

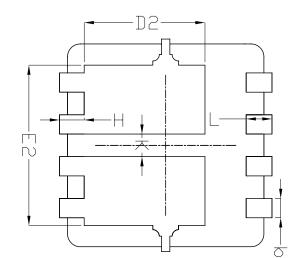
But Including Any Mismatch Between The Top And Bottom Of The Plastic Body.

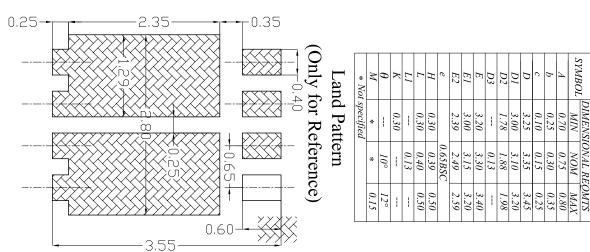
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Note:









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